



Evolution of High-Speed Computing Interfaces

Paving the way for 400GE in the data center

Virtual and augmented reality (VR/AR), Internet of Things (IoT), autonomous cars, and high-definition (HD) video streaming escalate the need for more and faster data, both in the core network and the data center. Consumers no longer tolerate even the smallest delay to data access. In some applications, such as autonomous driving and medical IoT devices, delayed communication can lead to life and death situations.

Data center networks need to move from 100 gigabit Ethernet (GE) to 400GE speeds to support the requirements of emerging technologies. Faster networking speeds require faster memory and faster serial bus communications. In addition to moving to 400GE speeds, data center operators need to move to the next generation of high-speed computing interfaces, such as Peripheral Component Interconnect Express (PCI Express® or PCIe®) and Double Data Rate (DDR) memory. Data center operators also need to consider new specialized interconnect technologies that offer alternatives to PCIe.

PCIe expansion bus speeds will move from PCIe 4.0 to PCIe 5.0 to support 400GE speeds. The same is true for memory, as DDR moves from DDR 4.0 to DDR 5.0. Increasing the speed of serial data communications requires high-speed precision testing at every level. Testing at these faster speeds requires full compliance testing to the latest standards.

Three key highlights in this paper:

- 5th generation computing standards
- Emerging new standards offer alternatives
- 400GE introduces new test challenges

5th Generation Computing Standards

Each generational change of high-speed computing standards provides new features and faster data transfer rates, creating new test challenges for digital designers. The need to measure complex specifications complicates the design and validation process and requires a long learning curve for test engineers. Since standards evolve quickly from one generation to the next, test engineers can save significant time and get their designs to market faster using test solutions that ensure full compliance with industry standards.

PCI Express evolves to PCIe 5.0

Server speeds increased from 16 gigabits per second (Gbps) to over 30 Gbps in about a year, and future technologies may use PAM4 to push data rates above 50 Gbps to support 400GE in the data center. PCIe 4.0, with a data rate of 16 gigatransfers per second (GT/s), is no longer sufficient to support 400GE speeds. As a result, the PCI Special Interest Group (PCISIG), the standard body that defines the PCI Express specifications, has fast-tracked the development of the PCIe 5.0 standard which is due for completion in 2019. With a data rate of 32 GT/s, PCIe 5.0 provides twice the throughput of PCIe 4.0.

DDR5 doubles the data rate of DDR4

Each new generation of the DDR synchronous dynamic random-access memory (SDRAM) standard delivers significant improvements over the previous generation, including increased speeds, reduced footprint, and improved power efficiency. DDR4 is designed for the computing server industry and supports data transfer speeds up to 3.2 GT/s. The Joint Electronic Devices Engineering Council (JEDEC), the organization that defines the DDR specifications, is currently working on the next generation of DDR memory, DDR5, to fulfill the need for faster data rates. DDR5 will operate at data rates up to 6.0 GT/s or higher and will effectively double the data rate of DDR4.



Emerging New Standards Offer Alternatives

New interconnect standards, such as Open Coherent Accelerator Processor Interface (OpenCAPI), Gen-Z, and Cache Coherent Interconnect for Accelerators (CCIX), offer alternatives to the PCIe standard. These bus standards specialize in areas where PCIe is not customized.

OpenCAPI accelerates computing

OpenCAPI is an open, coherent, high-performance bus standard that accelerates computing through tighter integration of different types of technologies, such as advanced memory, accelerators, networking, and storage, within servers. The OpenCAPI standard, defined by the OpenCAPI Consortium, provides 25 Gbps data rate and aims to improve server performance by moving computing power closer to the data. OpenCAPI enables a very low latency interface between the CPU and an attached device, removing bottlenecks caused by I/O inefficiencies.

Gen-Z targets memory-to-CPU connections

Gen-Z, defined by the Gen-Z Consortium, is an open interconnect standard optimized for storage technology to increase the speed of memory-to-CPU connections. Gen-Z version 1.0, based on IEEE-802.3 physical layer specifications, provides 25 GT/s and 28 GT/s interconnect speeds and is scalable to 112 GT/s and higher. Gen-Z components use low-latency read and write operations for direct data access with minimal application or processor involvement.

CCIX increases data throughput

The principle behind CCIX, defined by the CCIX Consortium, is to use the PCIe physical (PHY) layer but to change the function of the bus for increased efficiency and faster speeds. The CCIX standard currently supports data rates up to 25 Gbps and is expected to extend that to 40 Gbps soon. In addition to faster interconnect speeds, CCIX enables cache coherency. Cache coherency quickly propagates any changes to data in one area of memory to all other instances of the data stored in different memory locations throughout the entire system. For example, there can be a copy of data in main memory as well as one in the local cache of every processor that has previously requested the data. With cache coherency, CPUs can communicate faster with the rest of the system.

New interconnect standards emerge:

- OpenCAPI accelerates computing
- Gen-Z targets memory-to-CPU connections
- CCIX increases data throughput

400GE Introduces New Test Challenges

The design of high-speed serial data links becomes significantly more complex as data rates increase — channel topologies become more diverse, and the number of parameters tuned for active components multiply. Signal integrity at 400GE speeds is a critical challenge for high-speed computing interface designers. Design and simulation tools enable the optimization of the transmitter, receiver, and channel designs for best performance and reliability at the desired data rate. These tools allow designers to plan upfront to resolve signal integrity issues, ensure power efficiency, and stay within tight error margins before the first prototypes.

Test engineers must develop comprehensive test plans to ensure compliance with industry standards and interoperability with devices from other vendors. Testing next-generation standards is particularly challenging when test requirements differ drastically from one generation to the next. For example, the DDR5 standard specifies that test engineers need to test both the transmitter and the receiver. Previous DDR technologies required only transmitter testing. Testing new interconnect technologies, such as OpenCAPI, Gen-Z, or CCIX, is equally challenging since test engineers have never tested them before and need to ramp up on test requirements and procedures.

Compliance test software developed in accordance to industry standards can reduce test time down from days or weeks to hours. Industry compliant test solutions ensure that next-generation devices comply with industry standards and are interoperable with devices from other vendors. Using fully compliant test solutions, engineers can focus on designing next-generation devices, instead of learning the details of each new standard.

Conclusion

Data center operators know firsthand the ripple effects of emerging technologies such as VR/AR, IoT, and autonomous vehicles. As operators begin the migration of their data center networks from 100GE to 400GE, they need a migration plan that will take them to the next-generation of high-speed computing interfaces (e.g., PCIe or DDR).

New interconnect standards, such as OpenCAPI, Gen-Z, and CCIX, designed to optimize specific data transfer functions, provide alternatives to PCIe yet introduce another level of complexity for high-speed digital designers. Test solutions designed to test specific industry standards reduce test time and ensure compliance and interoperability of devices. Data center operators can ensure a smooth transition to the next speed class by choosing network equipment that has been thoroughly tested to conform to industry standards.

For information on how Keysight's solutions can help you address your high-speed computing interface design and test challenges, visit the following web pages:

- To accelerate the time-to-market of your gigabit digital designs, check out [High-Speed Digital System Design](#)
- To learn more about test solutions to simulate, characterize, and validate your PCIe designs, check out [PCI Express \(PCIe\) Design and Test](#)
- To learn how to quickly and accurately test all required parameters in your DDR designs and get them to market faster, check out [Double Data Rate \(DDR\) Memory Design and Test](#)

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